DESCRIPTION

The MPM3810A is an automotive-grade, step-down module converter with built-in power MOSFETs and an inductor. The module’s integrated inductor simplifies the power system design and provides easy and efficient use. The MPM3810A achieves 1.2A of peak output current from a 2.6V to 6V input voltage range with excellent load and line regulation. The output voltage is regulated as low as 0.6V. Only FB resistors and input/output capacitors are required to complete the design.

The constant-on-time control (COT) scheme provides fast transient response and eases loop stabilization. Full protection features include cycle-by-cycle current limiting and thermal shutdown.

The MPM3810A is ideal for a wide range of automotive applications including small ECUs, camera modules, telematics, and infotainment systems.

The MPM3810A is available in a small surface-mounted QFN-12 (2.5mmx3.0mmx0.9mm) package.

FEATURES

- Guaranteed Industrial/Automotive Temp
- Wide 2.6V to 6V Operating Input Range
- Adjustable Output from 0.6V
- Up to 1.2A Peak Output Current
- 100% Duty Cycle in Dropout
- Forced Continuous Conduction Mode (FCCM)
- EN and Power Good (PG) for Power Sequencing
- Cycle-by-Cycle Over-Current Protection (OCP)
- Short-Circuit Protection (SCP) with Hiccup Mode
- Requires only Four External Components: Ceramic Capacitors and FB Divider Resistors
- Available in a QFN-12 (2.5mmx3.0mmx0.9mm) Package
- Total Solution Size: 6mmx3.8mm
- Available in AEC-Q100

APPLICATIONS

- Automotive ECU
- Rear Cameras
- E-Call
- Telematics
- Infotainment Systems

All MPS parts are lead-free, halogen-free, and adhere to the RoHS directive. For MPS green status, please visit the MPS website under Quality Assurance. "MPS", the MPS logo, and "Simple, Easy Solutions" are trademarks of Monolithic Power Systems, Inc. or its subsidiaries.
**ORDERING INFORMATION**

<table>
<thead>
<tr>
<th>Part Number</th>
<th>Package</th>
<th>Top Marking</th>
</tr>
</thead>
<tbody>
<tr>
<td>MPM3810AGQB-AEC1*</td>
<td>QFN-12 (2.5mmx3.0mmx0.9mm)</td>
<td>See Below</td>
</tr>
<tr>
<td>MPM3810AGQBE-AEC1</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

* For Tape & Reel, add suffix –Z (e.g.: MPM3810AGQB-AEC1–Z).

**TOP MARKING**

(MPM3810AGQB-AEC1)

- BAL
- YWW
- LLL

(MPM3810AGQBE-AEC1)

- BHN
- YWW
- LLL

**PACKAGE REFERENCE**

QFN-12 (2.5mmx3.0mmx0.9mm)

**TOP VIEW**

- OUT_S
- AGND
- FB
- EN
- PG
- VIN
- OUT
- OUT

BAL: Product code of MPM3810AGQB-AEC1
Y: Year code
WW: Week code
LLL: Lot number

BHN: Product code of MPM3810AGQBE-AEC1
Y: Year code
WW: Week code
LLL: Lot number
PIN FUNCTIONS

<table>
<thead>
<tr>
<th>Pin #</th>
<th>Name</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1, 2</td>
<td>PGND</td>
<td>Power ground.</td>
</tr>
<tr>
<td>3, 4</td>
<td>N/C</td>
<td>Internal SW pad.</td>
</tr>
<tr>
<td>5, 6</td>
<td>OUT</td>
<td>Output voltage power rail. Connect the load to OUT. OUT requires an output capacitor.</td>
</tr>
<tr>
<td>7</td>
<td>VIN</td>
<td>Supply voltage. The MPM3810A operates from a +2.6V to +6V unregulated input. A decoupling capacitor is needed to prevent large voltage spikes from appearing at the input. Place the decoupling capacitor as close to VIN as possible.</td>
</tr>
<tr>
<td>8</td>
<td>PG</td>
<td>Power good indicator. The output of PG is an open drain with an internal pull-up resistor to VIN. PG is pulled up to VIN when the FB voltage is within 10% of the regulation level. If the FB voltage is out of that regulation range, PG is low.</td>
</tr>
<tr>
<td>9</td>
<td>EN</td>
<td>On/off control.</td>
</tr>
<tr>
<td>10</td>
<td>FB</td>
<td>Feedback. An external resistor divider from the output to GND tapped to FB sets the output voltage.</td>
</tr>
<tr>
<td>11</td>
<td>AGND</td>
<td>Analog ground for internal control circuit.</td>
</tr>
<tr>
<td>12</td>
<td>OUT_S</td>
<td>Output voltage sense.</td>
</tr>
</tbody>
</table>

ABSOLUTE MAXIMUM RATINGS (1)
Supply voltage (V_{IN}) ................. 6.5V
V_{SW} .................................. -0.3V (-5V for <10ns) to 6.5V (7V for <10ns)
All other pins ......................... -0.3V to 6.5V
Junction temperature .................. 150°C
Lead temperature ...................... 260°C
Continuous power dissipation (T_A = +25°C) (2) .............................................. 1.9W
Storage temperature ................... -65°C to +150°C

Recommended Operating Conditions
Supply voltage (V_{IN}) ................. 2.6V to 6V
Output voltage (V_{OUT}) ............... 12% x V_{IN} to V_{IN}
Operating junction temp. (T_J) ....... -40°C to +125°C

Thermal Resistance (3) \( \theta_{JA} \quad \theta_{JC} \)
QFN-12 (2.5mmx3.0mm) ............... 65 ...... 13 ...°C/W

NOTES:
1) Exceeding these ratings may damage the device.
2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-to-ambient thermal resistance \( \theta_{JA} \), and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by \( P_D (MAX) = (T_J (MAX) - T_A) / \theta_{JA} \). Exceeding the maximum allowable power dissipation produces an excessive die temperature, causing the device to go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
3) Measured on JESD51-7, 4-layer PCB.
### ELECTRICAL CHARACTERISTICS

$V_{IN} = 5V$, $T_J = -40°C$ to +125°C, unless otherwise noted. Typical values are at $T_J = +25°C$.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Feedback voltage</td>
<td>$V_{FB}$</td>
<td>$2.6V \leq V_{IN} \leq 6V$, $T_J = -40°C$ to +125°C</td>
<td>573</td>
<td>627</td>
<td>mV</td>
<td></td>
</tr>
<tr>
<td>Feedback current</td>
<td>$I_{FB}$</td>
<td>$V_{FB} = 0.63V$</td>
<td>10</td>
<td>1000</td>
<td>nA</td>
<td></td>
</tr>
<tr>
<td>P-FET switch-on resistance</td>
<td>$R_{DSON_P}$</td>
<td>$V_{FB} = 0.63V$</td>
<td>110</td>
<td>170</td>
<td>mΩ</td>
<td></td>
</tr>
<tr>
<td>N-FET switch-on resistance</td>
<td>$R_{DSON_N}$</td>
<td>$V_{FB} = 0.63V$</td>
<td>60</td>
<td>130</td>
<td>mΩ</td>
<td></td>
</tr>
<tr>
<td>Inductor L value</td>
<td>$L$</td>
<td>Inductance value at 1MHz</td>
<td>0.47</td>
<td></td>
<td>μH</td>
<td></td>
</tr>
<tr>
<td>Inductor DC resistance</td>
<td>$R_{DCR}$</td>
<td>$V_{FB} = 0.63V$</td>
<td>125</td>
<td></td>
<td>mΩ</td>
<td></td>
</tr>
<tr>
<td>Dropout resistance</td>
<td>$R_{DR}$</td>
<td>$100%$ on duty</td>
<td>235</td>
<td></td>
<td>mΩ</td>
<td></td>
</tr>
<tr>
<td>Switch leakage</td>
<td></td>
<td>$V_{EN} = 0V$, $V_{IN} = 6V$, $V_{SW} = 0V$ and $6V$, $T_J = +25°C$</td>
<td>0</td>
<td>1</td>
<td>μA</td>
<td></td>
</tr>
<tr>
<td>PFET current limit</td>
<td>$I_{ON}$</td>
<td>$T_J = +25°C$</td>
<td>1.6</td>
<td>2.1</td>
<td>2.6 A</td>
<td></td>
</tr>
<tr>
<td>On time</td>
<td>$T_{ON}$</td>
<td>$V_{IN} = 5V$, $V_{OUT} = 1.2V$</td>
<td>70</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{IN} = 3.6V$, $V_{OUT} = 1.2V$</td>
<td>100</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Switching frequency</td>
<td>$F_s$</td>
<td>$V_{IN} = 3.6V$, $V_{OUT} = 1.2V$</td>
<td>2400</td>
<td>3500</td>
<td>4200 kHz</td>
<td></td>
</tr>
<tr>
<td>Minimum off time</td>
<td>$T_{MIN-OFF}$</td>
<td>$V_{IN} = 3.6V$, $V_{OUT} = 1.2V$</td>
<td>60</td>
<td></td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>Soft-start time</td>
<td>$T_{SS-ON}$</td>
<td>$V_{IN} = 3.6V$, $V_{OUT} = 1.2V$</td>
<td>1.5</td>
<td></td>
<td>ms</td>
<td></td>
</tr>
<tr>
<td>Power good upper trip threshold</td>
<td>$P_{GH}$</td>
<td>FB voltage in respect to the regulation</td>
<td>+10</td>
<td></td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>Power good lower trip threshold</td>
<td>$P_{GL}$</td>
<td>$V_{EN} = 0V$, $V_{IN} = 6V$, $V_{SW} = 0V$ and $6V$, $T_J = +25°C$</td>
<td>-10</td>
<td></td>
<td>%</td>
<td></td>
</tr>
<tr>
<td>Power good delay</td>
<td>$P_{GD}$</td>
<td>$V_{IN} = 3.6V$, $V_{OUT} = 1.2V$</td>
<td>50</td>
<td></td>
<td>μs</td>
<td></td>
</tr>
<tr>
<td>Power good sink current capability</td>
<td>$V_{PG-L}$</td>
<td>Sink 1mA</td>
<td>0.4</td>
<td></td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Power good logic high voltage</td>
<td>$V_{PG-H}$</td>
<td>$V_{IN} = 5V$, $V_{FB} = 0.6V$</td>
<td>4.0</td>
<td></td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Power good internal pull-up resistor</td>
<td>$R_{PG}$</td>
<td>$V_{EN} = 2V$</td>
<td>550</td>
<td></td>
<td>kΩ</td>
<td></td>
</tr>
<tr>
<td>Under-voltage lockout threshold rising</td>
<td>$V_{UN}$</td>
<td>$V_{EN} = 2V$</td>
<td>2.2</td>
<td>2.4</td>
<td>2.6 V</td>
<td></td>
</tr>
<tr>
<td>Under-voltage lockout threshold hysteresis</td>
<td>$V_{UN}$</td>
<td>$V_{EN} = 2V$</td>
<td>300</td>
<td></td>
<td>mV</td>
<td></td>
</tr>
<tr>
<td>EN input logic low voltage</td>
<td></td>
<td>$V_{EN} = 0V$</td>
<td>0.4</td>
<td></td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>EN input logic high voltage</td>
<td></td>
<td>$V_{EN} = 0V$</td>
<td>1.2</td>
<td></td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>EN input current</td>
<td>$V_{EN}$</td>
<td>$V_{EN} = 2V$, $V_{FB} = 0.6V$</td>
<td>1.5</td>
<td></td>
<td>μA</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>$V_{EN} = 0V$</td>
<td>0.1</td>
<td>1</td>
<td>μA</td>
<td></td>
</tr>
</tbody>
</table>
**ELECTRICAL CHARACTERISTICS (continued)**

\( V_{\text{IN}} = 5\, \text{V},\ T_{\text{J}} = -40^\circ\text{C} \) to \( +125^\circ\text{C} \), unless otherwise noted. Typical values are at \( T_{\text{J}} = +25^\circ\text{C} \).

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Supply current (shutdown)</td>
<td></td>
<td>( V_{\text{EN}} = 0, \text{V}, \ T_{\text{J}} = +25^\circ\text{C} )</td>
<td>1</td>
<td></td>
<td></td>
<td>( \mu\text{A} )</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( V_{\text{EN}} = 0, \text{V}, \ T_{\text{J}} = -40^\circ\text{C} ) to ( +125^\circ\text{C} )</td>
<td>10</td>
<td></td>
<td></td>
<td>( \mu\text{A} )</td>
</tr>
<tr>
<td>Supply current (quiescent)</td>
<td></td>
<td>( V_{\text{EN}} = 0, \text{V}, \ T_{\text{J}} = +25^\circ\text{C} )</td>
<td>485</td>
<td>560</td>
<td></td>
<td>( \mu\text{A} )</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( V_{\text{EN}} = 0, \text{V}, \ T_{\text{J}} = -40^\circ\text{C} ) to ( +125^\circ\text{C} )</td>
<td>650</td>
<td></td>
<td></td>
<td>( \mu\text{A} )</td>
</tr>
<tr>
<td>Thermal shutdown (4)</td>
<td></td>
<td>( V_{\text{EN}} = 2, \text{V}, \ V_{\text{FB}} = 0.63, \text{V}, \ V_{\text{IN}} = 5, \text{V}, \ T_{\text{J}} = +25^\circ\text{C} )</td>
<td>150</td>
<td></td>
<td></td>
<td>( ^\circ\text{C} )</td>
</tr>
<tr>
<td>Thermal hysteresis (4)</td>
<td></td>
<td>( V_{\text{EN}} = 2, \text{V}, \ V_{\text{FB}} = 0.63, \text{V}, \ V_{\text{IN}} = 5, \text{V}, \ T_{\text{J}} = -40^\circ\text{C} ) to ( +125^\circ\text{C} )</td>
<td>30</td>
<td></td>
<td></td>
<td>( ^\circ\text{C} )</td>
</tr>
</tbody>
</table>

**NOTE:**

4) Not tested in production, guaranteed by design.
TYPICAL PERFORMANCE CHARACTERISTICS

\( V_{IN} = 5V, \ V_{OUT} = 1.2V, \ C_{IN} = 10\mu F, \ C_{OUT} = 20\mu F, \ T_A = +25^\circ C, \) unless otherwise noted.

**Shutdown Current vs. VIN**

**Maximum I_{OUT} vs. Ambient Temperature**

**Output Current Derating vs. Output Voltage**

**Efficiency vs. Load**

\( V_{OUT} = 1.2V \)

**Efficiency vs. Line**

\( V_{OUT} = 1.2V \)

**Load Regulation**

\( V_{OUT} = 1.2V \)
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

Vin = 5V, Cin = 10µF, Cout = 20µF, Ta = +25°C, unless otherwise noted.

**Line Regulation**

\[ V_{OUT} = 1.2V \]

**Efficiency vs. Load**

\[ V_{OUT} = 1.8V \]

**Efficiency vs. Voltage**

\[ V_{OUT} = 1.8V \]

**Load Regulation**

\[ V_{OUT} = 1.8V \]
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

VIN = 5V, VOUT = 1.2V, CIN = 10µF, COUT = 20µF, TA = +25°C, unless otherwise noted.

- P-FET Current Limit vs. TA
- Switch Frequency vs. TA
- Enable On/Off vs. TA
- Feedback Voltage vs. TA
- Supply Current vs. TA
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$V_{IN} = 5\, V$, $C_{IN} = 10\, \mu F$, $C_{OUT} = 20\, \mu F$, $T_A = +25^\circ C$, unless otherwise noted.

**Steady State**

$V_{IN} = 5\, V$, $V_{OUT} = 1.2\, V$, $I_{OUT} = 0.1\, A$

**Steady State**

$V_{IN} = 5\, V$, $V_{OUT} = 1.2\, V$, $I_{OUT} = 0.6\, A$

**Steady State**

$V_{IN} = 5\, V$, $V_{OUT} = 1.2\, V$, $I_{OUT} = 1.2\, A$

**Steady State**

$V_{IN} = 5\, V$, $V_{OUT} = 1.8\, V$, $I_{OUT} = 0.1\, A$

**Steady State**

$V_{IN} = 5\, V$, $V_{OUT} = 1.8\, V$, $I_{OUT} = 0.6\, A$

**Steady State**

$V_{IN} = 5\, V$, $V_{OUT} = 1.8\, V$, $I_{OUT} = 1.2\, A$
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

VIN = 5V, CIN = 10µF, COUT = 20µF, TA = +25°C, unless otherwise noted.

Power Up
VIN = 2.5V, VOUT = 1.2V, IOUT = 0.6A

Power Down
VIN = 2.5V, VOUT = 1.2V, IOUT = 0.6A

Power Up
VIN = 3.3V, VOUT = 1.8V, IOUT = 0.6A

Power Down
VIN = 3.3V, VOUT = 1.8V, IOUT = 0.6A

Enable On
VIN = 2.5V, VOUT = 1.2V, IOUT = 0.6A

Enable Off
VIN = 2.5V, VOUT = 1.2V, IOUT = 0.6A
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

VIN = 5V, Cin = 10µF, Cout = 20µF, Ta = +25°C, unless otherwise noted.

Enable On
VIN = 3.3V, VOUT = 1.8V, IOUT = 0.6A

Enable Off
VIN = 3.3V, VOUT = 1.8V, IOUT = 0.6A

Steady State
VIN = 5V, VOUT = 1.8V, IOUT = 0.6A

Steady State
VIN = 5V, VOUT = 1.2V, IOUT = 0.6A

Short Circuit
VIN = 5V, VOUT = 1.2V

Short-Circuit Recovery
VIN = 5V, VOUT = 1.2V
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

$V_{IN} = 5V$, $C_{IN} = 10\mu F$, $C_{OUT} = 20\mu F$, $T_A = +25^\circ C$, unless otherwise noted.

**Short-Circuit Entry**

$V_{IN} = 5V$, $V_{OUT} = 1.8V$

**Short Circuit**

$V_{IN} = 5V$, $V_{OUT} = 1.8V$

**Short-Circuit Recovery**

$V_{IN} = 5V$, $V_{OUT} = 1.2V$

**Transient Response**

$V_{IN} = 2.5V$, $V_{OUT} = 1.2V$, $I_{OUT} = 0 - 0.6A$, $0.25A/\mu s$

$V_{IN} = 3.3V$, $V_{OUT} = 1.2V$, $I_{OUT} = 0 - 0.6A$, $0.25A/\mu s$

$V_{IN} = 6V$, $V_{OUT} = 1.2V$, $I_{OUT} = 0 - 0.6A$, $0.25A/\mu s$
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

VIN = 5V, CIN = 10μF, COUT = 20μF, TA = +25°C, unless otherwise noted.

### Transient Response

| VIN = 2.5V, VOUT = 1.8V, IOUT = 0 - 0.6A, 0.25A/µs |
| CH1: VIN 2V/div. |
| CH3: VOUT/AC 20mV/div. |
| CH4: IOUT 500mA/div. |
| 200µs/div. |

| VIN = 3.3V, VOUT = 1.8V, IOUT = 0 - 0.6A, 0.25A/µs |
| CH1: VIN 2V/div. |
| CH3: VOUT/AC 20mV/div. |
| CH4: IOUT 500mA/div. |
| 200µs/div. |

| VIN = 6V, VOUT = 1.8V, IOUT = 0 - 0.6A, 0.25A/µs |
| CH1: VIN 5V/div. |
| CH3: VOUT/AC 20mV/div. |
| CH4: IOUT 500mA/div. |
| 200µs/div. |
Figure 1: Functional Block Diagram
OPERATION

The MPM3810A has an integrated inductor that simplifies the schematic and layout designs. Only FB resistors and input/output capacitors are required to complete the design. The MPM3810A uses constant-on-time control (COT) with input voltage feed-forward to stabilize the switching frequency over a full input range. At light load, the MPM3810A employs a proprietary control of the low-side switch and inductor current to improve efficiency.

Constant-On-Time Control (COT)

Compared to a fixed-frequency pulse-width modulation (PWM) control, COT control offers the advantage of a simpler control loop and faster transient response. By using input voltage feed-forward, the MPM3810A maintains a nearly constant switching frequency across the input and output voltage ranges. The on time of the switching pulse can be estimated with Equation (1):

\[ T_{\text{ON}} = \frac{V_{\text{OUT}}}{V_{\text{IN}}} \cdot 0.28 \mu s \]  

To prevent inductor current runaway during the load transition, the MPM3810A fixes the minimum off time at 60ns. This minimum off-time limit does not affect operation in a steady state.

The MPM3810A works in forced continuous conduction mode (CCM).

Enable (EN)

If the input voltage is greater than the under-voltage lockout threshold (UVLO) (typically 2.3V), the MPM3810A is enabled by pulling EN above 1.2V. Leave EN floating or pull EN down to ground to disable the MPM3810A. There is an internal 1M\( \Omega \) resistor from EN to ground.

Soft Start (SS)

The MPM3810A has a built-in soft start that ramps up the output voltage at a controlled slew rate to prevent overshoots during start-up. The soft-start time is about 1.5ms, typically.

Power Good Indicator (PG)

The MPM3810A has an open-drain pin with a 550k\( \Omega \) pull-up resistor for power good indication (PG). When FB is within \( \pm 10\% \) of the regulation voltage (i.e.: 0.6V), PG is pulled up to VIN by the internal resistor. If FB voltage is out of the \( \pm 10\% \) window, PG is pulled down to ground by an internal MOSFET. The MOSFET has a maximum \( R_{\text{DS(on)}} \) of less than 400\( \Omega \).

Current Limit

The MPM3810A has a typical 2.1A current limit for the high-side switch. When the high-side switch reaches the current limit, the MPM3810A is limited to the hiccup threshold until the current decreases. This prevents the inductor current from continuing to build and damaging components.

Short Circuit and Recovery

The MPM3810A enters short-circuit protection (SCP) mode when the current limit is reached. The MPM3810A then attempts to recover from the short circuit with hiccup mode. In SCP, the MPM3810A disables the output power stage, discharges the soft-start capacitor, and attempts to soft start again automatically. If the short circuit still remains after the soft start ends, the MPM3810A repeats the cycle until the short circuit is removed and the output rises back to the regulation level.
APPLICATION INFORMATION

Setting the Output Voltage

The external resistor divider is used to set the output voltage (see the Typical Application on page 18). The feedback resistor (R1) cannot be too large or too small considering the trade-off for stability and dynamics. Choose a value for R1 between 40kΩ to 80kΩ. R2 can then be calculated with Equation (2):

\[ R2 = \frac{R1}{V_{out}/0.6 - 1} \]  

(2)

The feedback circuit is shown in Figure 2.

![Figure 2: Feedback Network](image)

Table 1 lists the recommended resistor values for common output voltages.

<table>
<thead>
<tr>
<th>V_{out} (V)</th>
<th>R1 (kΩ)</th>
<th>R2 (kΩ)</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.0</td>
<td>40 (1%)</td>
<td>60 (1%)</td>
</tr>
<tr>
<td>1.2</td>
<td>40 (1%)</td>
<td>40 (1%)</td>
</tr>
<tr>
<td>1.8</td>
<td>60 (1%)</td>
<td>30 (1%)</td>
</tr>
<tr>
<td>2.5</td>
<td>80 (1%)</td>
<td>25 (1%)</td>
</tr>
<tr>
<td>3.3</td>
<td>80 (1%)</td>
<td>17.7 (1%)</td>
</tr>
</tbody>
</table>

Selecting the Input Capacitor

The input current to the step-down converter is discontinuous and therefore requires a capacitor to supply AC current while maintaining the DC input voltage. For optimal performance, use low ESR capacitors. Ceramic capacitors with X5R or X7R dielectrics are highly recommended for their low ESR and small temperature coefficients. For most applications, a 10μF capacitor is sufficient.

For a higher output voltage, a 22μF may be needed to enhance system stability.

Since the input capacitor absorbs the input switching current, it requires an adequate ripple current rating. The RMS current in the input capacitor can be estimated with Equation (3):

\[ I_{C1} = I_{LOAD} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \]  

(3)

The worst-case condition occurs at V_{IN} = 2V_{OUT}, shown in Equation (4):

\[ I_{C1} = \frac{I_{LOAD}}{2} \]  

(4)

For simplification, choose an input capacitor with an RMS current rating greater than half of the maximum load current.

The input capacitor can be electrolytic, tantalum, or ceramic. When using electrolytic or tantalum capacitors, add a small, high-quality ceramic capacitor (i.e.: 0.1μF) as close to the IC as possible. When using ceramic capacitors, ensure they have enough capacitance to provide a sufficient charge to prevent an excessive voltage ripple at the input. The input voltage ripple caused by the capacitance is estimated with Equation (5):

\[ \Delta V_{IN} = \frac{I_{LOAD}}{f_s \times C1} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \]  

(5)

Selecting the Output Capacitor

The output capacitor (C_{OUT}) is required to maintain the DC output voltage. For the best performance, use low ESR ceramic capacitors to keep the output voltage ripple low. The output voltage ripple is estimated with Equation (6):

\[ \Delta V_{OUT} = \frac{V_{OUT}}{f_s \times L_1} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times \left(R_{ESR} + \frac{1}{8 \times f_s \times C2}\right) \]  

(6)

Where L_1 is the inductor value, and R_{ESR} is the equivalent series resistance (ESR) value of the output capacitor (L_1 is 0.47μH).

When using ceramic capacitors, the impedance at the switching frequency is dominated by the capacitance. The output voltage ripple is caused mainly by the capacitance.
For simplification, the output voltage ripple is estimated with Equation (7):

\[
\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{8 \times f_S^2 \times L_i \times C_2} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}ight)
\]  

(7)

When using tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, the output ripple can be approximated with Equation (8):

\[
\Delta V_{\text{OUT}} = \frac{V_{\text{OUT}}}{f_S \times L_i} \times \left(1 - \frac{V_{\text{OUT}}}{V_{\text{IN}}}ight) \times R_{\text{ESR}}
\]  

(8)

The characteristics of the output capacitor affect the stability of the regulation system.

**PCB Layout Guidelines**

Efficient PCB layout is critical for stable operation. The module’s integrated inductor simplifies the schematic and layout design. Only FB resistors and input/output capacitors are needed to complete the design. For best results, refer to Figure 3 and Figure 4 and follow the guidelines below.

1. Place the high-current paths (PGND, VIN, and OUT) very close to the device with short, direct, and wide traces.
2. Place the input capacitor as close to VIN and PGND as possible.
3. Place the external feedback resistors next to FB.
4. Keep the switching node away from the feedback network.

For additional device applications, please refer to related evaluation board datasheets.
Figure 5: Typical Application Circuit
PACKAGE INFORMATION

QFN-12 (2.5mmx3.0mmx0.9mm)

NOTE:
1) ALL DIMENSIONS ARE IN MILLIMETERS
2) SHADED AREA IS THE KEEPOUT ZONE. THE EXPOSED BOTTOM METAL PADS ENCLOSED BY THIS ZONE IS NOT TO BE CONNECTED TO ANY PCB METAL TRACE & VIA ELECTRICALLY OR MECHANICALLY
3) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
4) LEAD COPLANARITY SHALL BE 0.10 MILLIMETERS MAX.
5) JEDEC REFERENCE IS MO220.
6) DRAWING IS NOT TO SCALE

RECOMMENDED LAND PATTERN